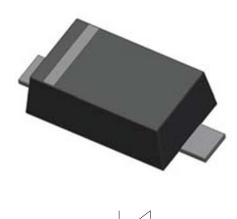






Small-Signal Fast Switching Diodes



Features

Moisture sensitivity level 1

• Reverse voltage: 80V

Average forward current : 100mA

Application

• High frequency rectifier

Signal switching

Mechanical data

• Package: SOD-523

• Terminals: Tin plated leads, solderable per

J-STD-002 and JESD22-B102

■ Maximum Ratings (Ta=25°C Unless otherwise specified)

Parameter	Symbol	Unit	Value
Device marking code			А
Repetitive peak reverse voltage	V_{RRM}	V	90
Forward current	I _{FM}	mA	225
Average rectified output current	Io	mA	100
Non-repetitive surge peak forward current @ t=8.3ms half-sine wave			2
Non-repetitive surge peak forward current @ t=1ms square wave	I _{FSM}	A	1.5
Power dissipation	P _D	mW	150
Junction temperature	TJ	°C	-55 to +150
Storage temperature	T_{STG}	℃	-55 to +150







■ Electrical Characteristics (Ta=25°C Unless otherwise specified)

Parameter	Symbol	Unit	Conditions	Min	Тур	Max
Reverse voltage	V_{R}	٧	I _R =100uA	80		
Forward voltage	V _F	V	I _F =100mA			1.2
Reverse leakage current	I _R	uA	V _R =80V			0.1
Junction capacitance	Cj	pF	V _R = 0.5V, f =1MHZ			3
Reverse recovery time	Trr	ns	V_R =6 V , I_F =10 m A, R_L =100 Ω			4

■ Thermal Characteristics

Parameter	Symbol	Unit	Value
Thermal resistance, junction-to-ambient	R ₀ J-A ⁽¹⁾	°C/W	833
Thermal resistance, junction-to-case	R ₀ J-C ⁽¹⁾	°C/W	667

Note:

(1) Thermal resistance from junction to ambient and from junction to case mounted on P.C.B. with 8mm*9mm copper pad areas





RohS COMPLIANT

■Characteristics

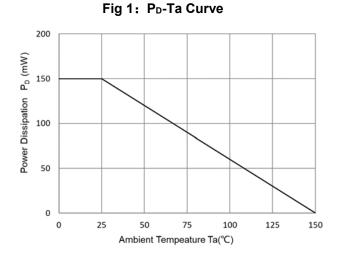


Fig 2: Capacitance Capability

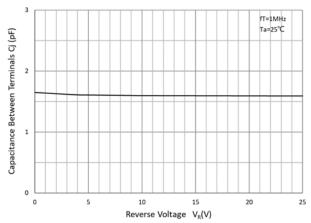


Fig 3: Typical Forward Characteristics

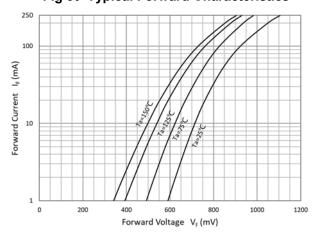
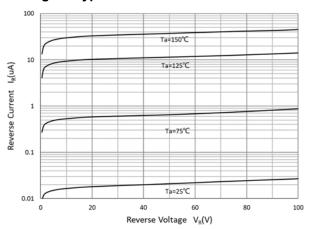


Fig 4: Typical Reverse Characteristics



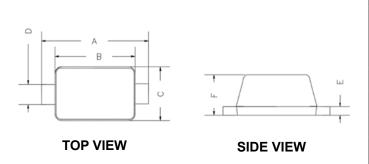




■Ordering Information

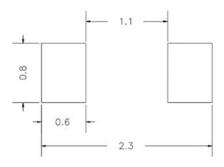
Preferred P/N	Packing code	Unit weight(g)	Minimum package(pcs)	Inner box quantity(pcs)	Outer carton quantity(pcs)	Delivery mode
1SS400	F2	Approximate 0.002	8000	80000	320000	7" reel
1SS400	F3	Approximate 0.002	3000	30000	120000	7" reel

■ Outline Dimensions



DIMENSIONS					
DIM	INC	HES	ММ		
	MIN	MAX	MN	MAX	
А	0.059	0.067	1.500	1.700	
В	0.043	0.051	1.100	1.300	
С	0.028	0.035	0.700	0.900	
D	0.010	0.014	0.250	0.350	
E	0.002	0.008	0.050	0.200	
F	0.020	0.028	0.500	0.700	

■ Suggested Pad Layout



UNIT: mm





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